

90A, 100V N-CHANNEL MOSFET

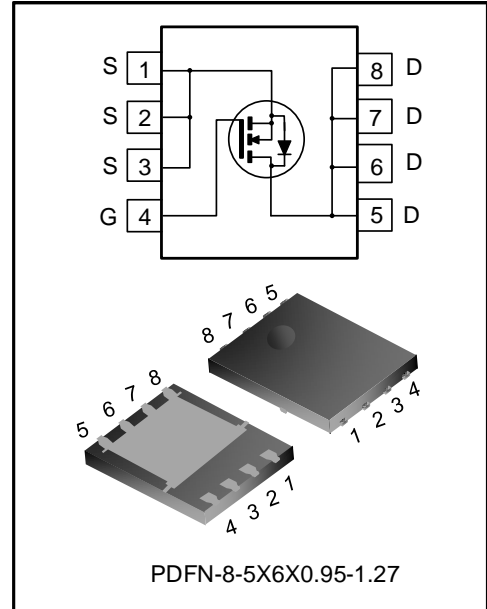
DESCRIPTION

SVGP107R0NL5 is an N-channel enhancement mode power MOS field effect transistor which is produced using Silan's LVMOS technology. The improved process and cell structure have been especially tailored to minimize on-state resistance, provide superior switching performance.

This device is widely used in UPS and Power Management for Inverter Systems.

FEATURES

- ◆ 90A, 100V, $R_{DS(on)(typ.)}=6.3m\Omega@V_{GS}=10V$
- ◆ Low gate charge
- ◆ Low C_{rss}
- ◆ Fast switching
- ◆ Improved dv/dt capability
- ◆ 100% avalanche tested
- ◆ Pb-free lead plating
- ◆ RoHS compliant



KEY PERFORMANCE PARAMETERS

Characteristics	Ratings	Unit
V_{DS}	100	V
$V_{GS(th)}$	2.0~3.5	V
$R_{DS(on),max.}$	7.0	$m\Omega$
I_D	90	A
$Q_{g,typ.}$	48	nC

ORDERING INFORMATION

Part No.	Package	Marking	Hazardous Substance Control	Packing Type
SVGP107R0NL5TR	PDFN-8-5X6X0.95-1.27	P107R0NL5	Halogen free	Tape&Reel

ABSOLUTE MAXIMUM RATINGS (UNLESS OTHERWISE NOTED, $T_J=25^{\circ}\text{C}$)

Characteristics	Symbol	Test conditions	Ratings			Unit
			Min.	Typ.	Max.	
Drain-source Voltage	V_{DS}	--	100	--	--	V
Gate-source Voltage	V_{GS}	--	-20	--	20	V
Drain Current (Note 1)	I_D	$T_C=25^{\circ}\text{C}$	--	--	90	A
		$T_C=100^{\circ}\text{C}$	--	--	57	A
Drain Current Pulsed (Note 2)	I_{DM}	$T_C=25^{\circ}\text{C}$	--	--	360	A
Power Dissipation (Note 3)	P_D	$T_C=25^{\circ}\text{C}$	--	--	119	W
Single Pulsed Avalanche Energy	E_{AS}	$L=0.5\text{mH}, V_{DD}=80\text{V}, R_G=25\Omega$, starting temperature $T_J=25^{\circ}\text{C}$	--	--	272	mJ
Single Pulsed Avalanche Current	I_{AS}	--	--	--	33	A
Operation Junction Temperature Range	T_J	--	-55	--	150	$^{\circ}\text{C}$
Storage Temperature Range	T_{stg}	--	-55	--	150	$^{\circ}\text{C}$

THERMAL CHARACTERISTICS

Characteristics	Symbol	Test conditions	Ratings			Unit
			Min.	Typ.	Max.	
Thermal Resistance, Junction-case, Bottom	$R_{\theta JC}$	--	--	--	1.05	$^{\circ}\text{C}/\text{W}$
Thermal Resistance, Junction-ambient	$R_{\theta JA}$	--	--	--	50	$^{\circ}\text{C}/\text{W}$
Soldering Temperature (SMD)	T_{sold}	Reflow soldering: $10\pm 1\text{sec}, 3\text{times}$	--	--	260	$^{\circ}\text{C}$

ELECTRICAL CHARACTERISTICS (UNLESS OTHERWISE NOTED, $T_J=25^\circ\text{C}$)

Static characteristics

Characteristics	Symbol	Test conditions	Ratings			Unit
			Min.	Typ.	Max.	
Drain-source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V, I_D=250\mu A$	100	--	--	V
Drain-source Leakage Current	I_{DSS}	$V_{DS}=100V, V_{GS}=0V, T_J=25^\circ\text{C}$	--	--	1.0	μA
		$V_{DS}=100V, V_{GS}=0V, T_J=125^\circ\text{C}$	--	10	--	
Gate-source Leakage Current	I_{GSS}	$V_{GS}=\pm 20V, V_{DS}=0V$	--	--	± 100	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{GS}=V_{DS}, I_D=250\mu A$	2.0	--	3.5	V
Static Drain-source	$R_{DS(on)}$	$V_{GS}=10V, I_D=50A$	--	6.3	7.0	m Ω
On State Resistance		$V_{GS}=6V, I_D=25A$	--	8.0	14	
Gate Resistance	R_G	f=1MHz	--	2.0	--	Ω

Dynamic characteristics

Characteristics	Symbol	Test conditions	Ratings			Unit
			Min.	Typ.	Max.	
Input Capacitance	C_{iss}	f=1MHz, $V_{GS}=0V, V_{DS}=50V$	--	3458	--	pF
Output Capacitance	C_{oss}		--	454	--	
Reverse Transfer Capacitance	C_{rss}		--	12	--	
Turn-on Delay Time	$t_{d(on)}$	$V_{DD}=50V, V_{GS}=10V,$ $R_G=1.6\Omega, I_D=25A$ (Notes 4,5)	--	23	--	ns
Turn-on Rise Time	t_r		--	51	--	
Turn-off Delay Time	$t_{d(off)}$		--	39	--	
Turn-off Fall Time	t_f		--	12	--	
Total Gate Charge	Q_g	$V_{DD}=50V, V_{GS}=10V, I_D=25A$ (Notes 4,5)	--	48	--	nC
Gate-source Charge	Q_{gs}		--	22	--	
Gate-drain Charge	Q_{gd}		--	7.4	--	
Gate-plateau Voltage	$V_{plateau}$		--	5.8	--	

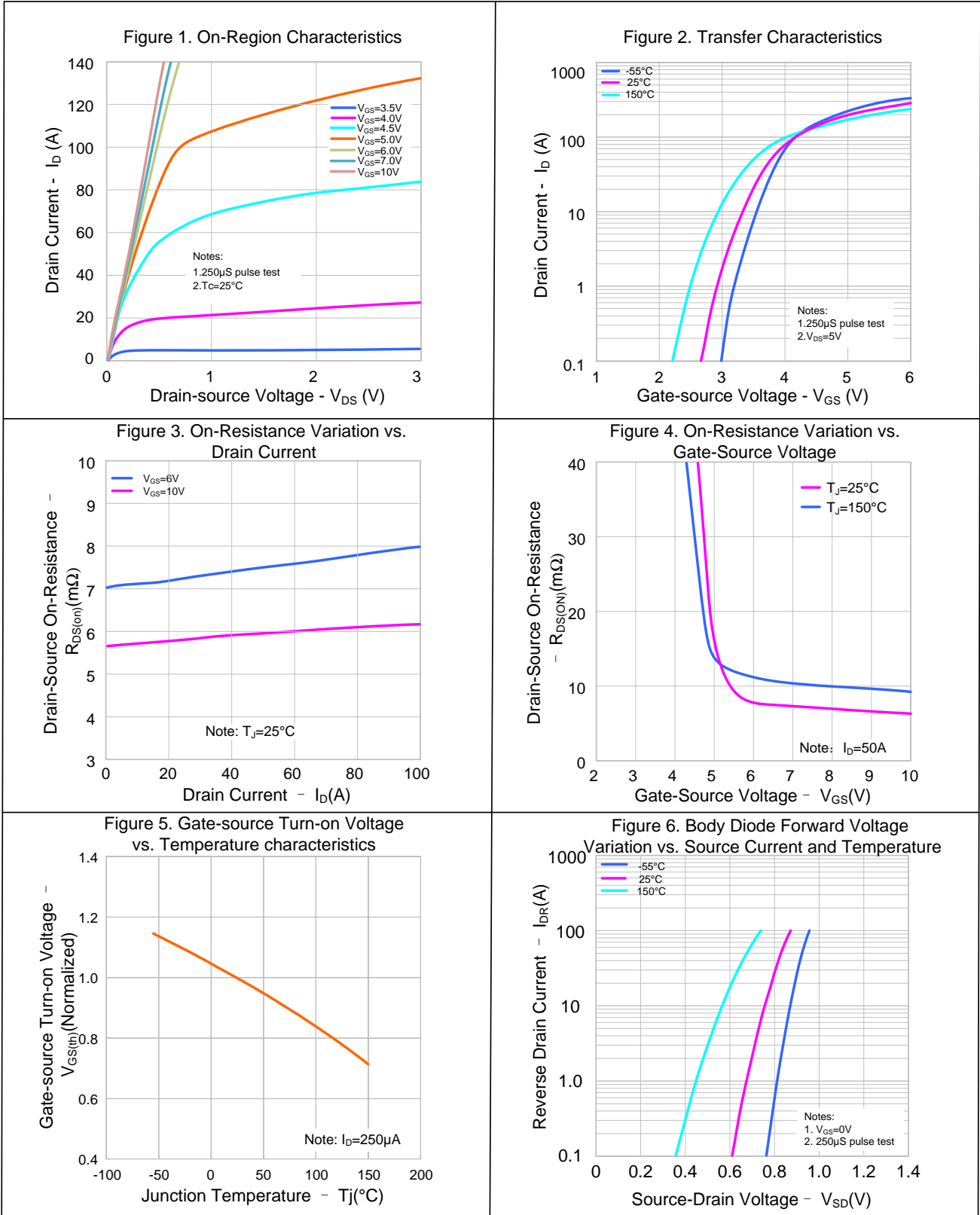
Reverse diode characteristics

Characteristics	Symbol	Test conditions	Ratings			Unit
			Min.	Typ.	Max.	
Continuous Diode Forward Current	I_S	$T_C=25^\circ\text{C}$, integral reverse P-N junction diode in the MOSFET	--	--	90	A
Diode Pulse Current	$I_{S,pulse}$		--	--	360	
Diode Forward Voltage	V_{SD}	$I_S=50A, V_{GS}=0V$	--	--	1.4	V
Reverse Recovery Time	T_{rr}	$I_S=25A, V_{GS}=0V, dI_F/dt=100A/\mu s$ (Note 4)	--	59	--	ns
Reverse Recovery Charge	Q_{rr}		--	0.1	--	μC

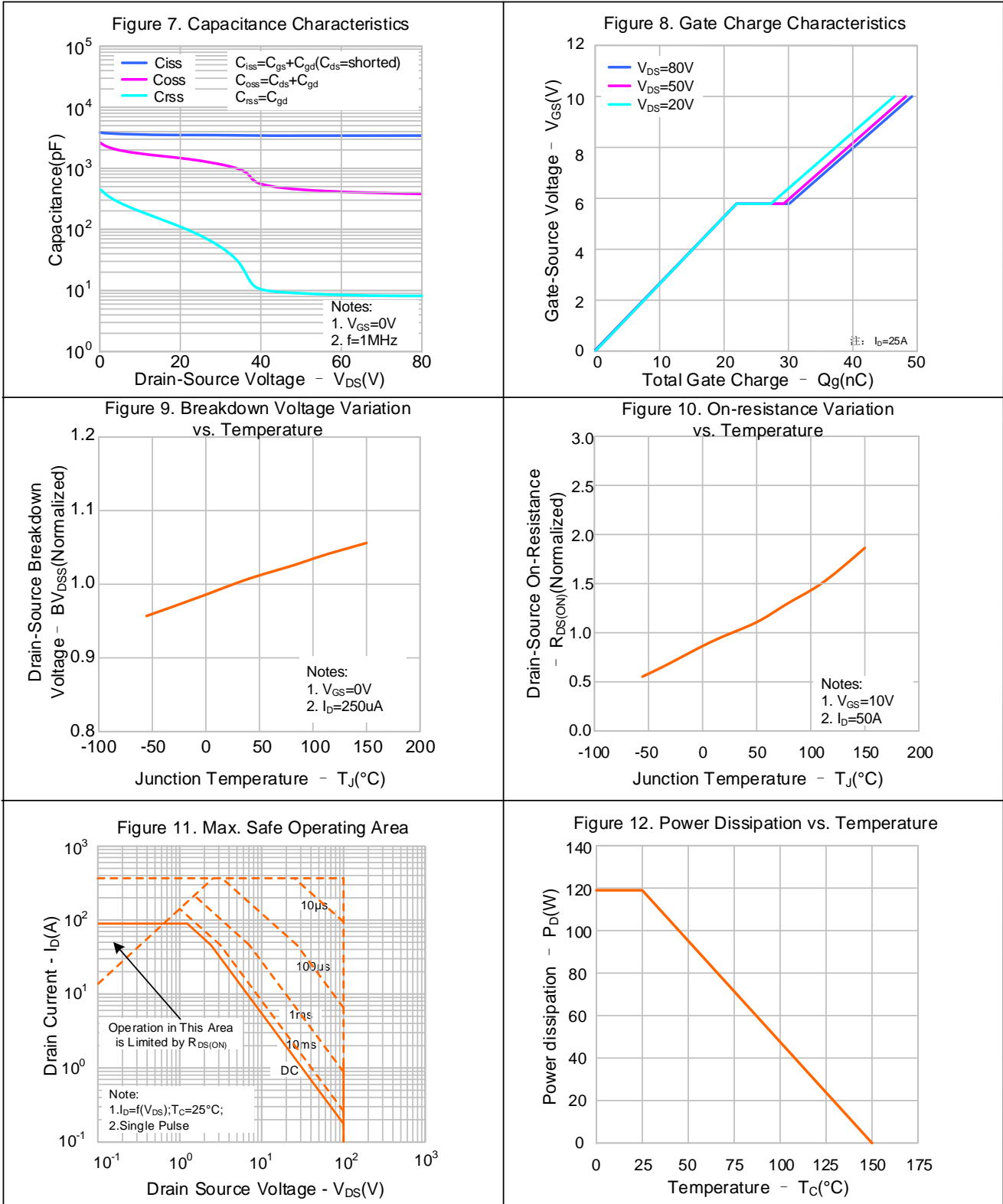
Notes:

- The rated value only refers to the maximum absolute value at the case temperature of 25°C in the specification. If the case temperature is higher than 25°C , it should be derated according to the actual environmental conditions;
- Pulse time $5\mu s$, pulse width is limited by the maximum junction temperature;
- The dissipation power will change with temperature, derating above 25°C : $0.95W/^\circ\text{C}$;
- Pulse Test: Pulse width $\leq 300\mu s$, Duty cycle $\leq 2\%$;
- Essentially independent of operating temperature.

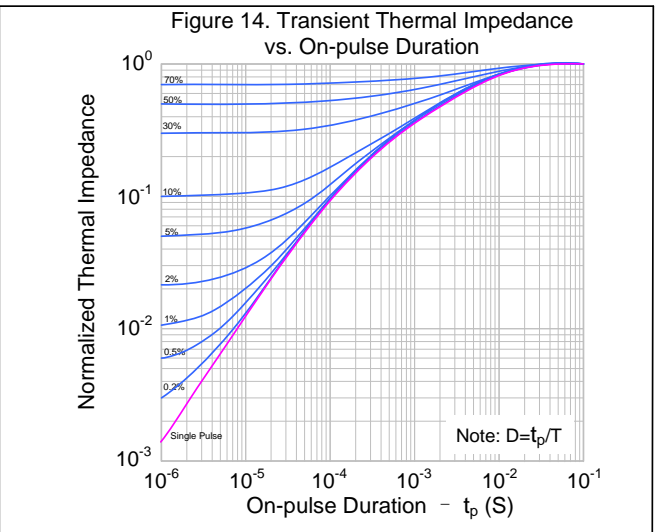
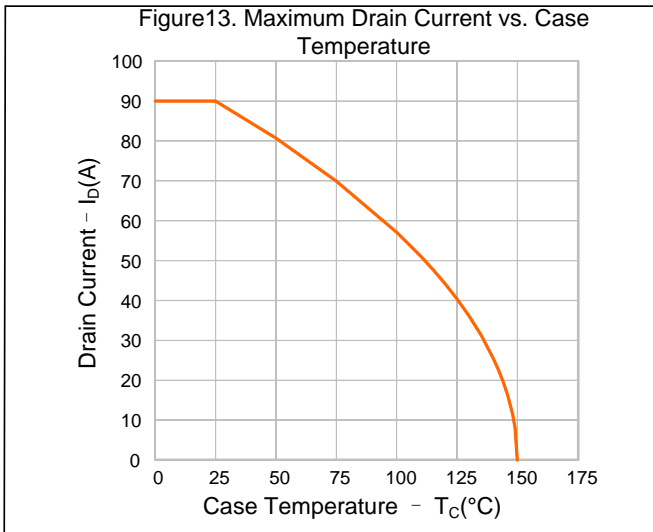
TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS (CONTINUED)

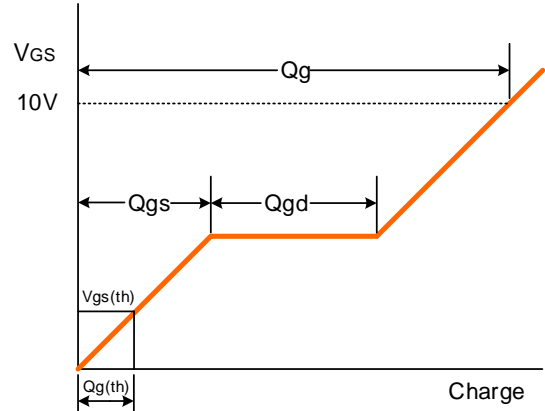
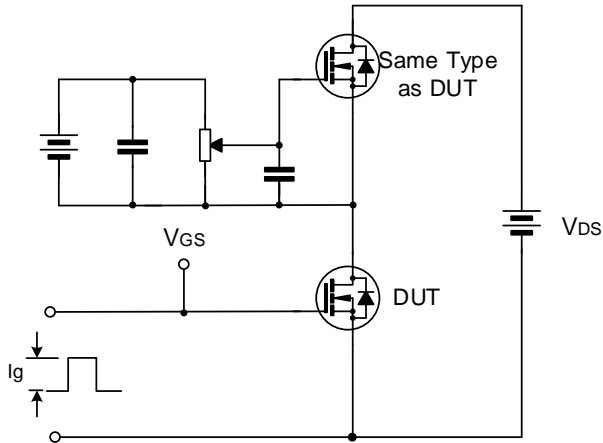


TYPICAL CHARACTERISTICS (CONTINUED)

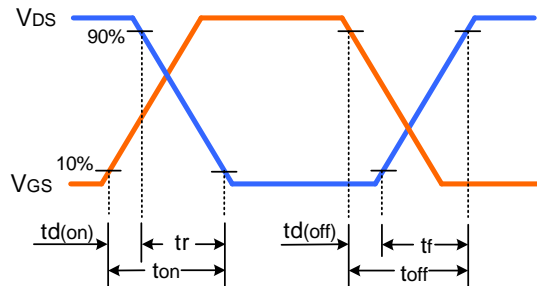
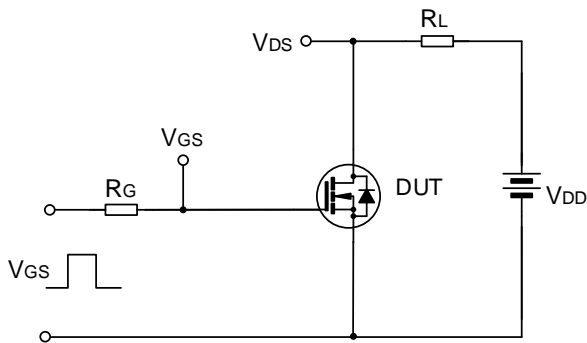


TYPICAL TEST CIRCUIT

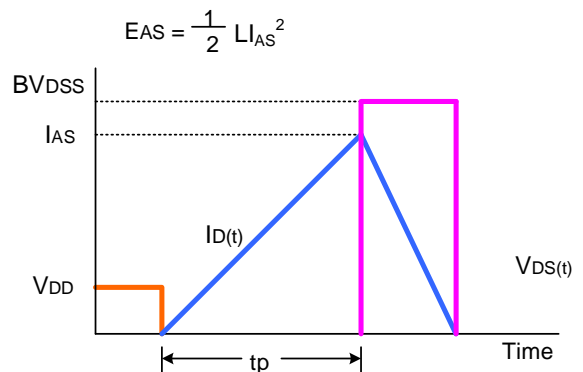
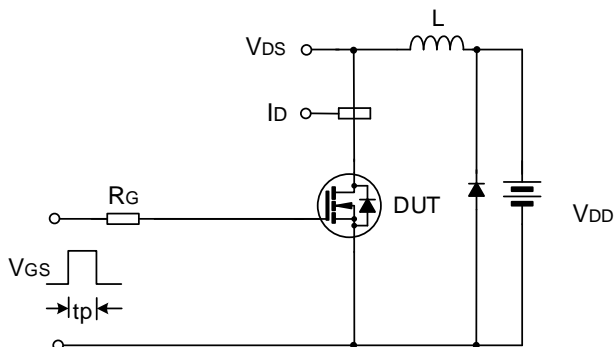
Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveform



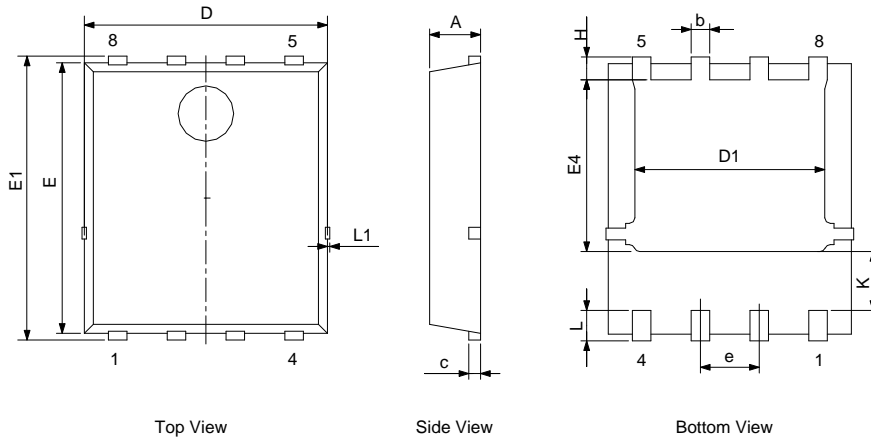
Unclamped Inductive Switching Test Circuit & Waveform



PACKAGE OUTLINE

PDFN-8-5X6X0.95-1.27

UNIT: mm



SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	0.90	—	1.20
c	0.154	0.25	0.354
D	4.80	—	5.40
E	5.66	—	6.06
D1	3.76	—	4.30
E1	5.90	—	6.35
b	0.30	—	0.55
K	1.10	1.30	1.50
e	1.07	1.27	1.37
E4	3.34	—	3.92
L	0.30	0.60	0.71
L1	—	—	0.12
H	0.40	—	0.71



MOS DEVICES OPERATE NOTES:

Electrostatic charges may exist in many things. Please take following preventive measures to prevent effectively the MOS electric circuit as a result of the damage which is caused by discharge:

- The operator must put on wrist strap which should be earthed to against electrostatic.
- Equipment cases should be earthed.
- All tools used during assembly, including soldering tools and solder baths, must be earthed.
- MOS devices should be packed in antistatic/conductive containers for transportation.

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Rev.: 1.5

Revision History:

1. Delete the wave soldering condition
 2. Update the typical test circuit
 3. Update the important notice
-

Rev.: 1.4

Revision History:

1. Update SOA
 2. Update important notice
-

Rev.: 1.3

Revision History:

1. Update Turn-on Rise Time
-

Rev.: 1.2

Revision History:

1. Modify electrical characteristics
 2. Update figure 5 and figure 11
 3. Add figures 13, 14
-

Rev.: 1.1

Revision History:

1. The upper limit of RG was modified to 5.0ohm(original 10ohm).
 2. Update the template
 3. Add figures 4, 5, and 12
-

Rev.: 1.0

Revision History:

1. First release
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